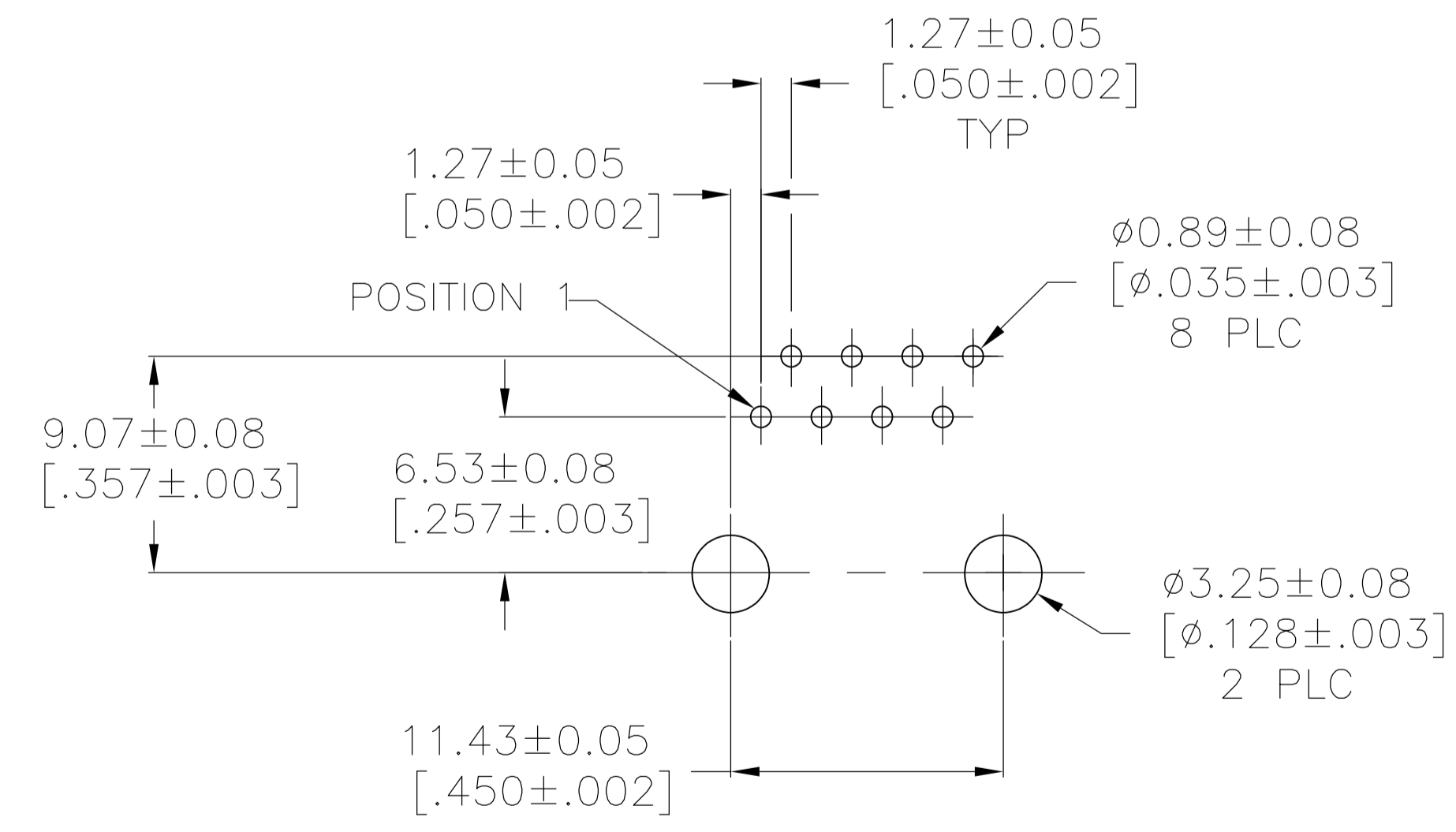
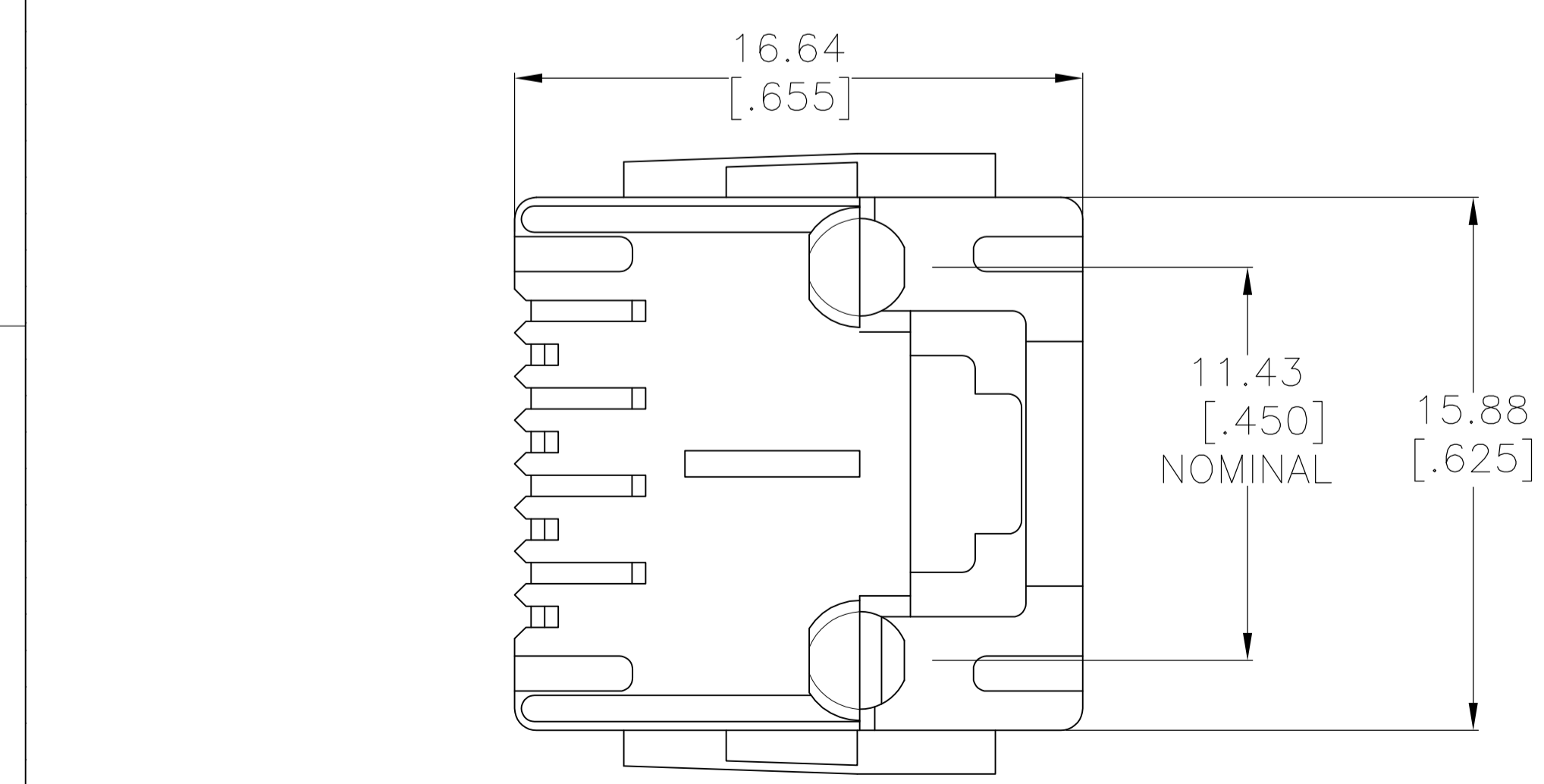


RECOMMENDED PANEL CUTOUT  
SCALE 4:1



RECOMMENDED PRINTED CIRCUIT BOARD LAYOUT  
COMPONENT SIDE  
SCALE 4:1

- MATERIAL: HOUSING: PBT POLYESTER, COLOR: BLACK  
TERMINAL: 0.36[.014] THICK PHOS BRONZE PLATED WITH 1.27µm [.000050] MIN THICK HARD GOLD IN LOCALIZED GOLD PLATE AREA AND 3.81µm [.000150] MIN THICK MATTE TIN IN SOLDER AREA OVER 1.27µm [.000050] MIN THICK NICKEL UNDERPLATE
- CAVITY CONFORMS TO FCC RULES AND REGULATIONS PART 68 REA BULLETIN 345-81, PE-76 SPECIFICATION FOR MODULAR TELEPHONE HARDWARE
- ALL DIMENSIONS SHOWN ARE MAXIMUM UNLESS OTHERWISE SPECIFIED

5520260-4  
PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT.		DIN G. ATTADIA - 06/JUN/2005	STE TE Connectivity	
DIMENSIONS: mm [INCHES]		CHK J. WESTMAN	NAME MODULAR JACK ASSEMBLY, TOP ENTRY, 8 POSITION, KEYED, FLANGELESS, WITH PANEL STOPS	
TOLERANCES UNLESS OTHERWISE SPECIFIED:		APVD S. FLICKINGER	PRODUCT SPEC 108-1163	
0 PLC ± -		APPLICATION SPEC 114-2048		
1 PLC ± -		SIZE A1		
2 PLC ± -		CAGE CODE 00779		
3 PLC ± -		DRAWING NO 5520260		
4 PLC ± -		RESTRICTED TO -		
ANGLES ± -		WEIGHT -		
MATERIAL SEE NOTE 1		CUSTOMER DRAWING		
FINISH SEE NOTE 1		SCALE 6:1		
		SHEET 1 OF 1		
		REV C1		